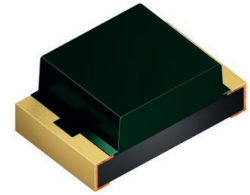


# SFH 2711 A01

## Chip LED

Silicon PIN Photodiode with  $V_{\lambda}$  Characteristics



## Applications

- Ambient Light Sensors
- Industrial Automation (Machine Controls, Light Barriers, Vision Controls)

## Features:

- Package: black epoxy
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Very small SMT package
- Good match to human eye sensitivity ( $V_{\lambda}$ )
- Sensitivity to IR radiation ( $\lambda > 750\text{nm}$ )  $< 1\%$

## Ordering Information

Type	Photocurrent <sup>1)</sup> $E_v = 1000 \text{ lx; white LED; } V_R = 5 \text{ V}$ $I_P$	Photocurrent typ. $E_v = 1000 \text{ lx; white LED; } V_R = 5 \text{ V}$ $I_P$	Ordering Code
SFH 2711 A01	$\geq 0.056 \mu\text{A}$	$0.12 \mu\text{A}$	Q65112A4787

## Maximum Ratings

$T_A = 25\text{ °C}$

Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min.	-40 °C
		max.	100 °C
Storage temperature	$T_{stg}$	min.	-40 °C
		max.	100 °C
Reverse voltage	$V_R$	max.	16 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$	max.	2 kV

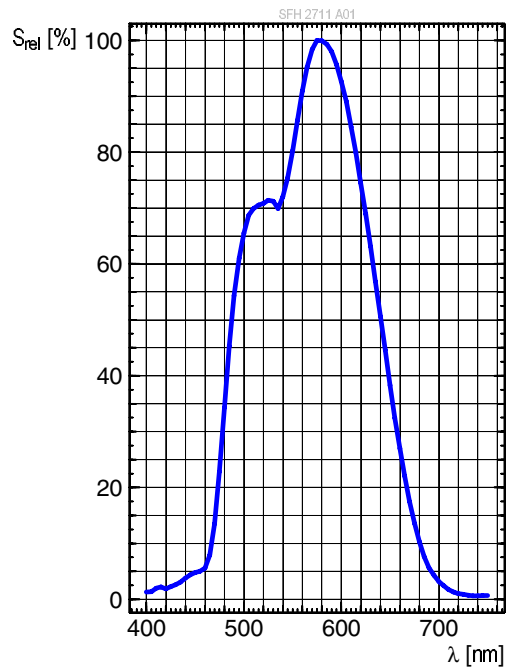
## Characteristics

$T_A = 25\text{ °C}$

Parameter	Symbol		Values
Spectral sensitivity $V_R = 5\text{ V}$ ; Std. Light A; $T = 2856\text{ K}$	S	typ.	0.115 nA/lx
Wavelength of max sensitivity	$\lambda_{S\text{ max}}$	typ.	580 nm
Spectral range of sensitivity	$\lambda_{10\%}$	typ.	470 ... 670 nm
Radiant sensitive area	A	typ.	0.35 mm <sup>2</sup>
Dimensions of active chip area	L x W	typ.	0.59 x 0.59 mm x mm
Half angle	$\varphi$	typ.	55 °
Dark current $V_R = 5\text{ V}$	$I_R$	typ. max.	0.01 nA 5 nA
Open-circuit voltage $E_v = 1000\text{ lx}$ ; Std. Light A; $V_R = 0\text{ V}$	$V_O$	min. typ.	300 mV 377 mV
Short-circuit current $E_v = 1000\text{ lx}$ ; Std. Light A; $V_R = 0\text{ V}$	$I_{SC}$	typ.	0.115 $\mu\text{A}$
Rise time $V_R = 5\text{ V}$ , $R_L = 50\text{ Ohm}$ , $\lambda = 530\text{ nm}$	$t_r$	typ.	0.06 $\mu\text{s}$
Fall time $V_R = 5\text{ V}$ , $R_L = 50\text{ Ohm}$ , $\lambda = 530\text{ nm}$	$t_f$	typ.	0.06 $\mu\text{s}$
Forward voltage 0	$V_F$	typ.	0.70 V
Capacitance $V_R = 0\text{ V}$ ; $f = 1\text{ MHz}$ ; $E = 0$	$C_0$	typ.	28 pF

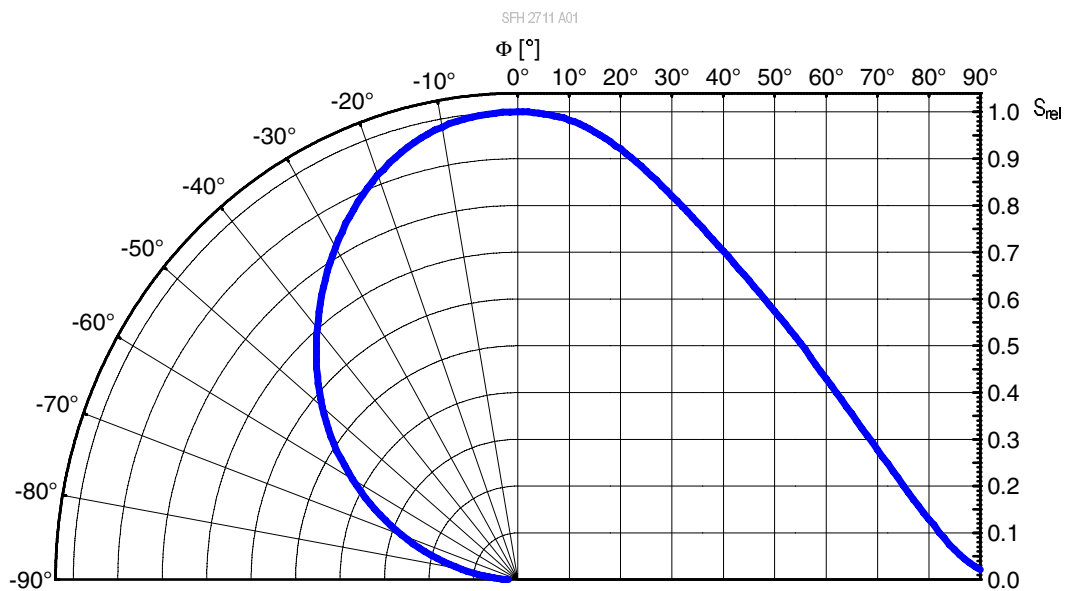
## Relative Spectral Sensitivity 2), 3)

$$S_{rel} = f(\lambda)$$



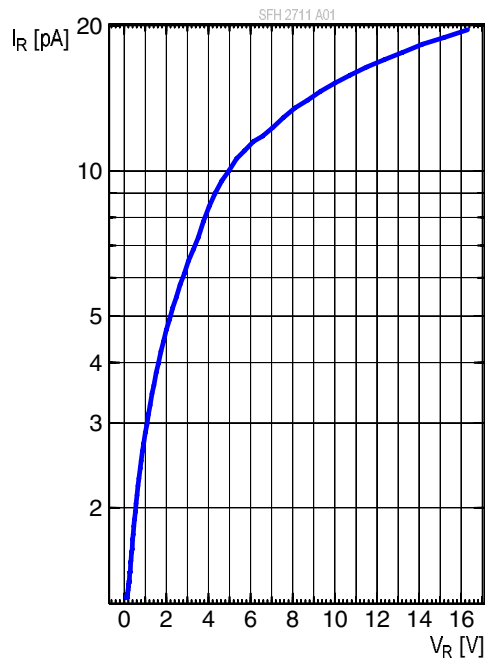
## Directional Characteristics 2), 3)

$$S_{rel} = f(\varphi)$$



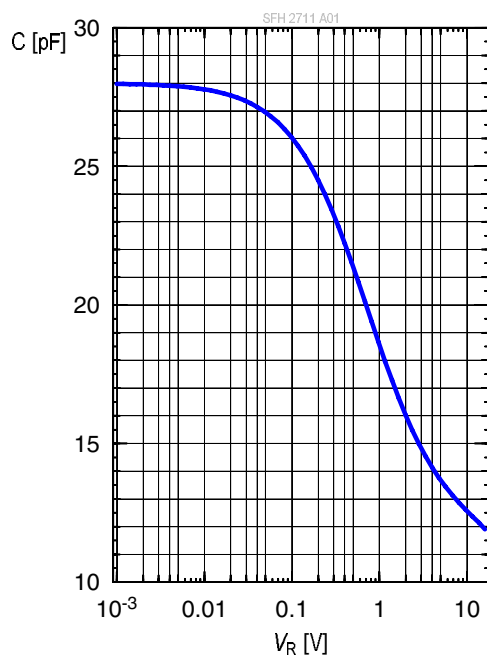
### Dark Current <sup>2), 3)</sup>

$$I_R = f(V_R); E = 0$$

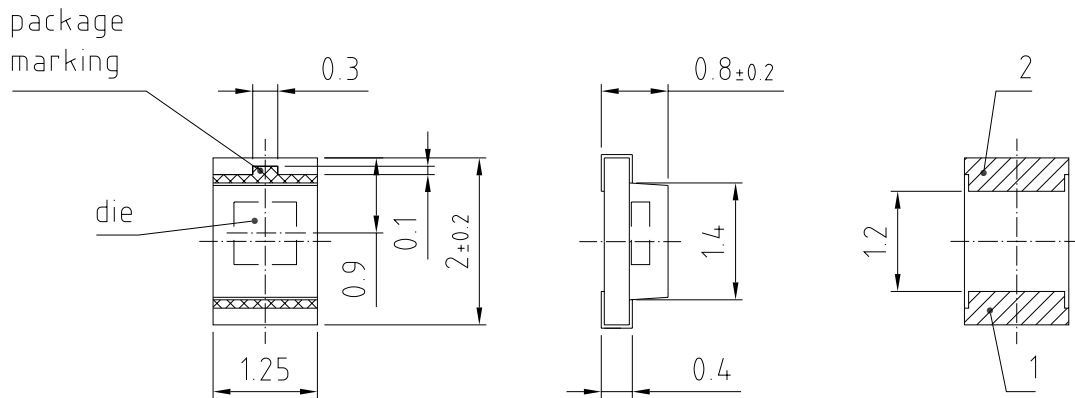


### Capacitance <sup>2), 3)</sup>

$$C = f(V_R); f = 1\text{MHz}; E = 0; T_A = 25^\circ\text{C}$$



**Dimensional Drawing** <sup>4)</sup>



general tolerance  $\pm 0.1$   
 lead finish Au

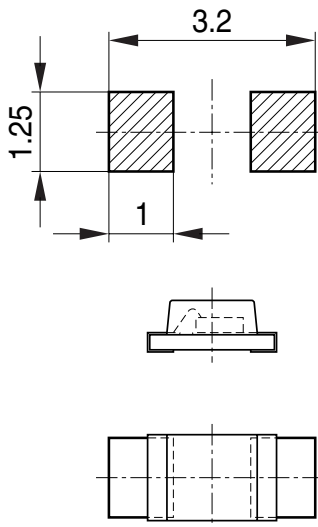
C67062-A0256-A1..-02

**Further Information:**

- Approximate Weight:** 3.8 mg
- Package marking:** Cathode
- Corrosion test:** Class: 3B  
 Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC 60068-2-43)

Pin	Description
1	Anode
2	Cathode

**Recommended Solder Pad** <sup>4)</sup>

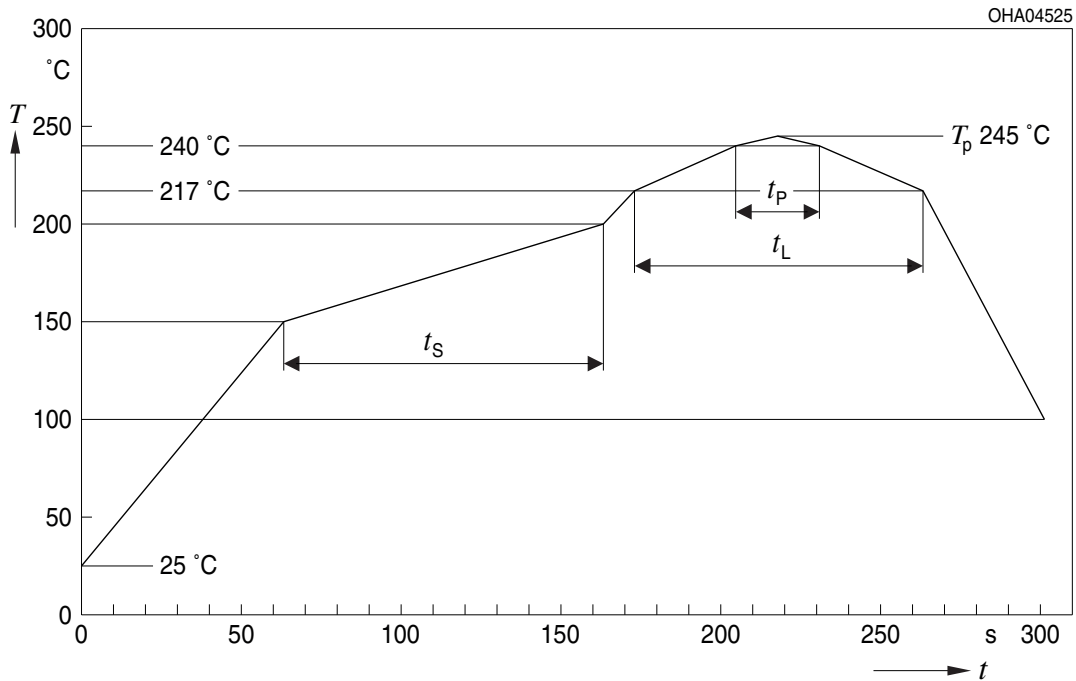


Bauteil positioniert  
Component location on pad

OHFP2578

## Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E

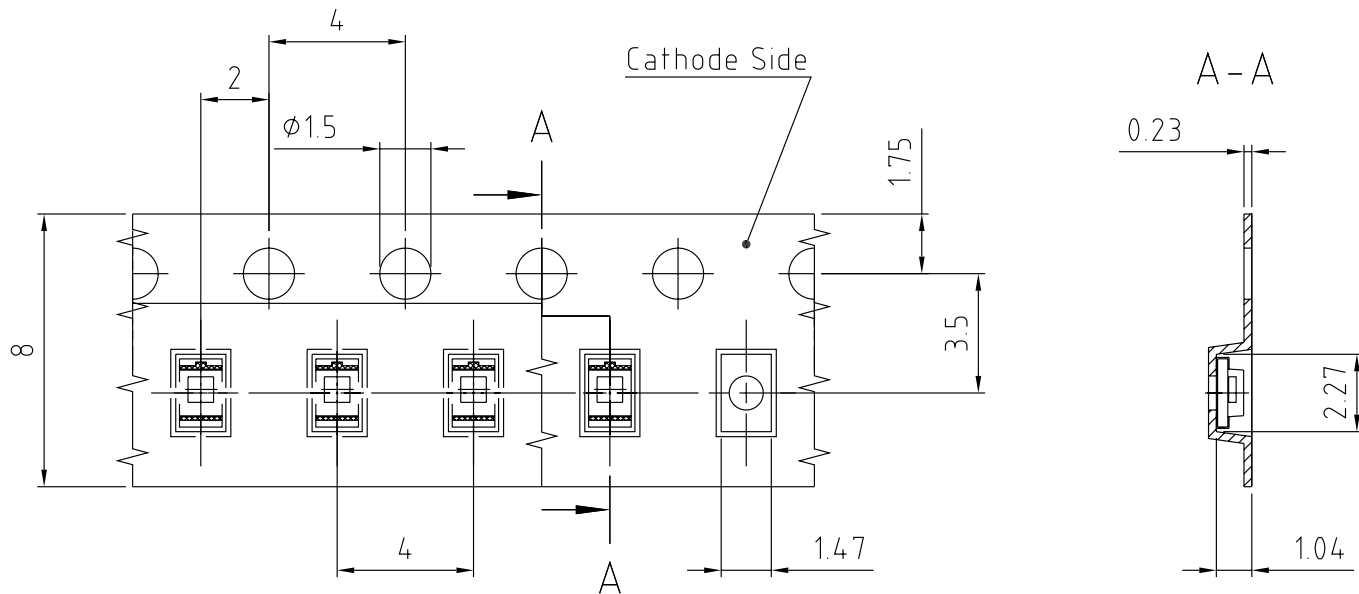


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5 \text{ K}$	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component  
 \*) slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

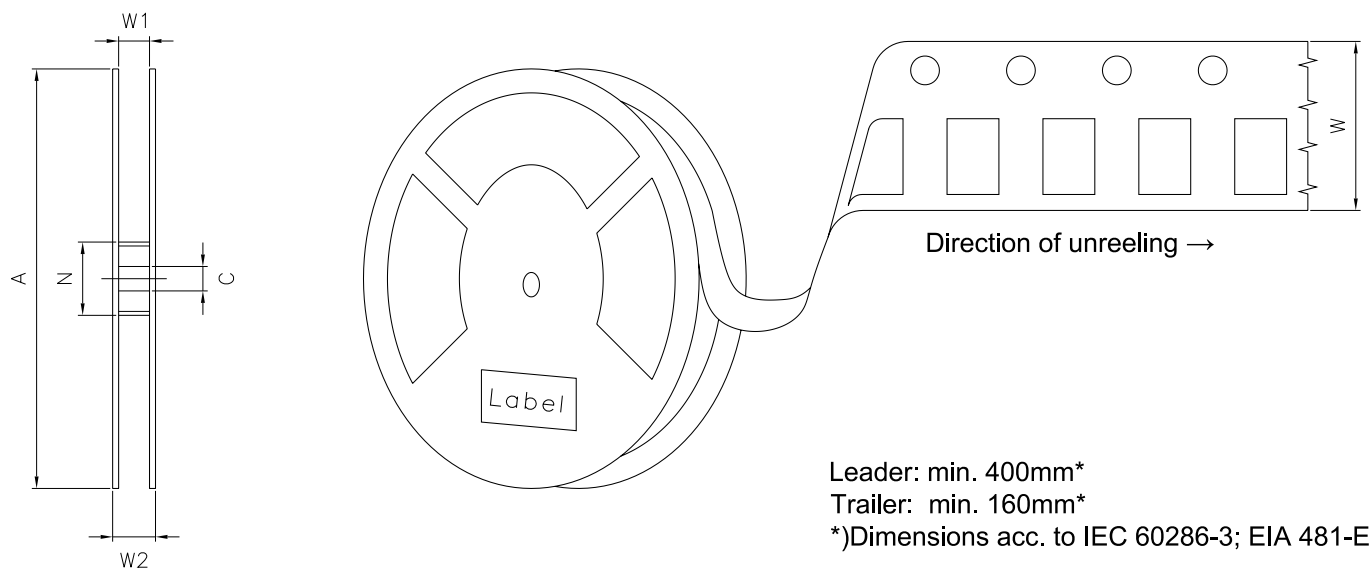


**Taping** <sup>4)</sup>



C67062-A0256-B1-03

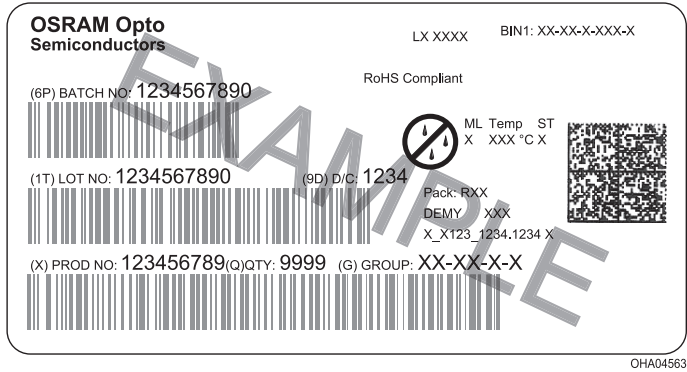
## Tape and Reel <sup>5)</sup>



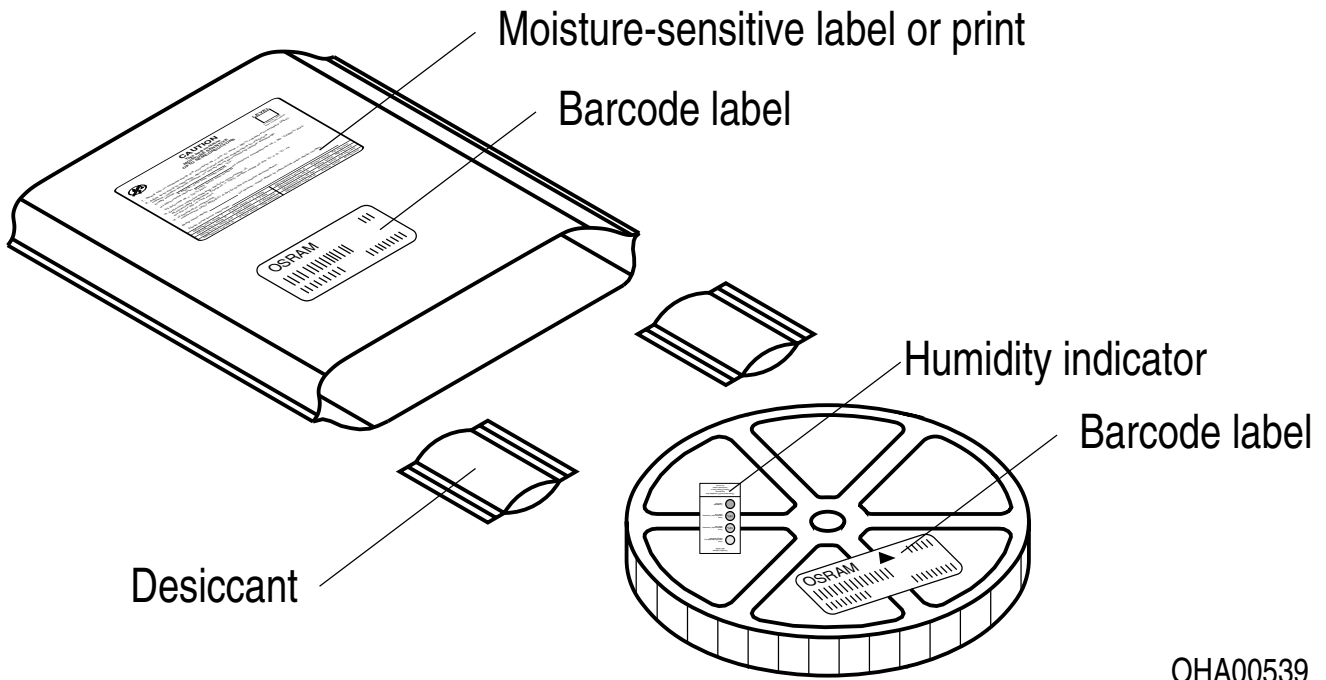
### Reel Dimensions

A	W	$N_{\min}$	$W_1$	$W_{2\max}$	Pieces per PU
180 mm	$8 + 0.3 / - 0.1$ mm	60 mm	$8.4 + 2$ mm	14.4 mm	3000

## Barcode-Product-Label (BPL)



## Dry Packing Process and Materials <sup>4)</sup>



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

## Disclaimer

### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### **Product and functional safety devices/applications or medical devices/applications**

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

## Glossary

- 1) **Photocurrent:** The photocurrent values are measured (by irradiating the devices with a homogenous light source and applying a voltage to the device) with a tolerance of  $\pm 11\%$ .
- 2) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 3) **Testing temperature:**  $T_A = 25^\circ\text{C}$  (unless otherwise specified)
- 4) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 5) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

---

## Revision History

Version	Date	Change
1.1	2020-09-21	Taping Schematic Transportation Box Dimensions of Transportation Box
1.2	2021-10-01	Brand

Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product  
Leibnizstraße 4, D-93055 Regensburg  
www.osram-os.com © All Rights Reserved.



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。